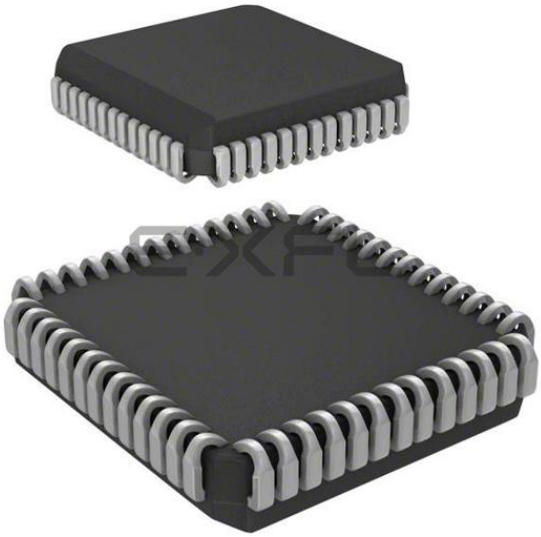


Welcome to E-XFL.COM

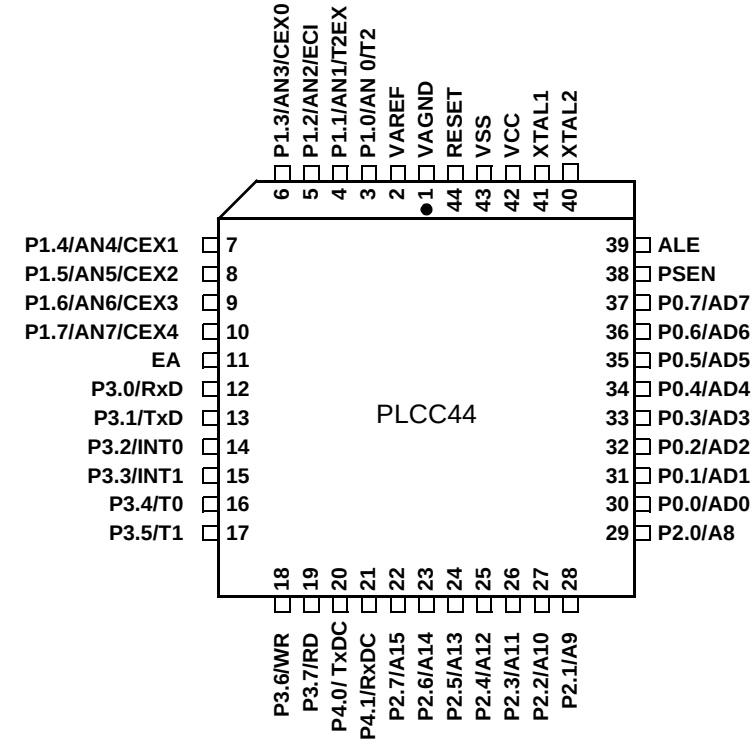
What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	80C51
Core Size	8-Bit
Speed	40MHz
Connectivity	CANbus, SPI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	36
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	52-LCC (J-Lead)
Supplier Device Package	52-PLCC (19.15x19.15)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at89c51cc03ca-s3sum

Pin Configuration



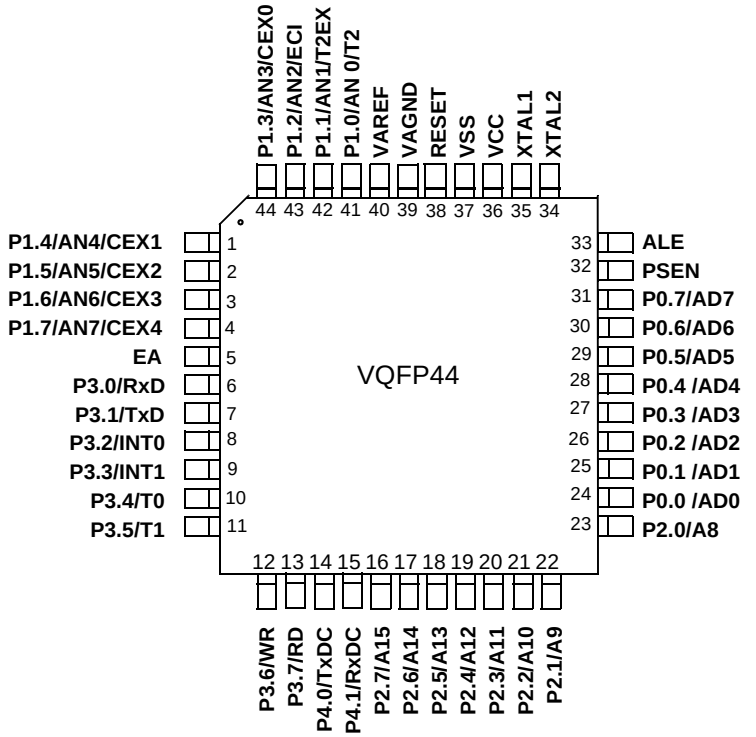


Table 3. CKCON1 Register

CKCON1 (S:9Fh)
Clock Control Register 1

7	6	5	4	3	2	1	0
							SPIX2

Bit Number	Bit Mnemonic	Description
7-1	-	**Reserved** The value read from these bits is indeterminate. Do not set these bits.
0	SPIX2	**SPI clock** (1) Clear to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.

Note: 1. This control bit is validated when the CPU clock bit X2 is set; when X2 is low, this bit has no effect.

Reset Value = 0000 0000b

Entering Power-Down Mode

To enter Power-Down mode, set PD bit in PCON register. The AT89C51CC03 enters the Power-Down mode upon execution of the instruction that sets PD bit. The instruction that sets PD bit is the last instruction executed.

Exiting Power-Down Mode

Note: If VCC was reduced during the Power-Down mode, do not exit Power-Down mode until VCC is restored to the normal operating level.

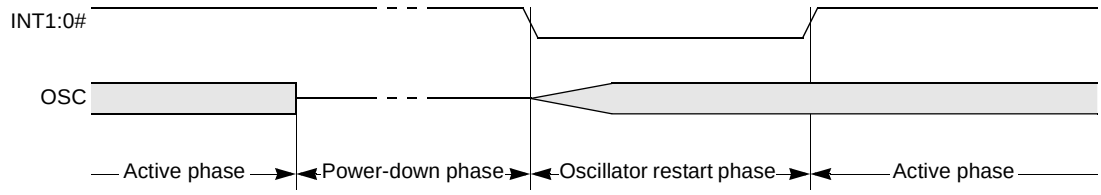
There are two ways to exit the Power-Down mode:

1. Generate an enabled external interrupt.
   – The AT89C51CC03 provides capability to exit from Power-Down using INT0#, INT1#.
   Hardware clears PD bit in PCON register which starts the oscillator and restores the clocks to the CPU and peripherals. Using INTx# input, execution resumes when the input is released (see Figure 19). Execution resumes with the interrupt service routine. Upon completion of the interrupt service routine, program execution resumes with the instruction immediately following the instruction that activated Power-Down mode.

Note: The external interrupt used to exit Power-Down mode must be configured as level sensitive (INT0# and INT1#) and must be assigned the highest priority. In addition, the duration of the interrupt must be long enough to allow the oscillator to stabilize. The execution will only resume when the interrupt is deasserted.

Note: Exit from power-down by external interrupt does not affect the SFRs nor the internal RAM content.

Figure 19. Power-Down Exit Waveform Using INT1:0#



2. Generate a reset.
   – A logic high on the RST pin clears PD bit in PCON register directly and asynchronously. This starts the oscillator and restores the clock to the CPU and peripherals. Program execution momentarily resumes with the instruction immediately following the instruction that activated Power-Down mode and may continue for a number of clock cycles before the internal reset algorithm takes control. Reset initializes the AT89C51CC03 and vectors the CPU to address 0000h.

Note: During the time that execution resumes, the internal RAM cannot be accessed; however, it is possible for the Port pins to be accessed. To avoid unexpected outputs at the Port pins, the instruction immediately following the instruction that activated the Power-Down mode should not write to a Port pin or to the external RAM.

Note: Exit from power-down by reset redefines all the SFRs, but does not affect the internal RAM content.

EEPROM Data Memory

The 2-Kbyte on-chip EEPROM memory block is located at addresses 0000h to 07FFh of the XRAM/ERAM memory space and is selected by setting control bits in the EECON register. A read in the EEPROM memory is done with a MOVX instruction.

A physical write in the EEPROM memory is done in two steps: write data in the column latches and transfer of all data latches into an EEPROM memory row (programming).

The number of data written on the page may vary from 1 up to 128 Bytes (the page size). When programming, only the data written in the column latch is programmed and a ninth bit is used to obtain this feature. This provides the capability to program the whole memory by Bytes, by page or by a number of Bytes in a page. Indeed, each ninth bit is set when the writing the corresponding byte in a row and all these ninth bits are reset after the writing of the complete EEPROM row.

Write Data in the Column Latches

Data is written by byte to the column latches as for an external RAM memory. Out of the 11 address bits of the data pointer, the 4 MSBs are used for page selection (row) and 7 are used for byte selection. Between two EEPROM programming sessions, all the addresses in the column latches must stay on the same page, meaning that the 4 MSB must no be changed.

The following procedure is used to write to the column latches:

- Save and disable interrupt.
- Set bit EEE of EECON register
- Load DPTR with the address to write
- Store A register with the data to be written
- Execute a MOVX @DPTR, A
- If needed loop the three last instructions until the end of a 128 Bytes page
- Restore interrupt.

Note: The last page address used when loading the column latch is the one used to select the page programming address.

Programming

The EEPROM programming consists of the following actions:

- writing one or more Bytes of one page in the column latches. Normally, all Bytes must belong to the same page; if not, the first page address will be latched and the others discarded.
- launching programming by writing the control sequence (50h followed by A0h) to the EECON register.
- EEBUSY flag in EECON is then set by hardware to indicate that programming is in progress and that the EEPROM segment is not available for reading.
- The end of programming is indicated by a hardware clear of the EEBUSY flag.

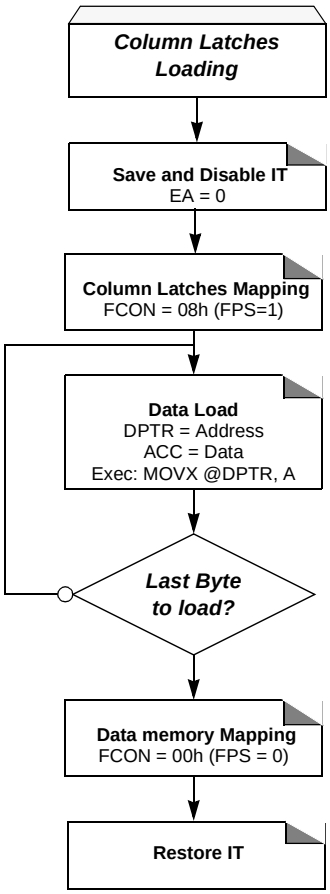
Note: The sequence 5xh and Axh must be executed without instructions between then otherwise the programming is aborted.

Read Data

The following procedure is used to read the data stored in the EEPROM memory:

- Save and disable interrupt
- Set bit EEE of EECON register
- Load DPTR with the address to read
- Execute a MOVX A, @DPTR
- Restore interrupt

Figure 25. Column Latches Loading Procedure



Note: The last page address used when loading the column latch is the one used to select the page programming address.

Programming the Flash Spaces

User

The following procedure is used to program the User space and is summarized in Figure 26:

- Load up to one page of data in the column latches from address 0000h to FFFFh.
- Save and Disable the interrupts.
- Launch the programming by writing the data sequence 50h followed by A0h in FCON register (only from FM1).
  The end of the programming indicated by the FBUSY flag cleared.
- Restore the interrupts.

Extra Row

The following procedure is used to program the Extra Row space and is summarized in Figure 26:

- Load data in the column latches from address FF80h to FFFFh.
- Save and Disable the interrupts.
- Launch the programming by writing the data sequence 52h followed by A2h in FCON register (only from FM1).
  The end of the programming indicated by the FBUSY flag cleared.
- Restore the interrupts.

For slaves A and B, bit 2 is a don't care bit; for slave C, bit 2 is set. To communicate with all of the slaves, the master must send an address FFh. To communicate with slaves A and B, but not slave C, the master can send and address FBh.

Registers

Table 25. SCON Register

SCON (S:98h)
Serial Control Register

7	6	5	4	3	2	1	0
FE/SM0	**SM1**	**SM2**	**REN**	**TB8**	**RB8**	**TI**	**RI**

Bit Number	Bit Mnemonic	Description
7	FE	**Framing Error bit (SMOD0=1**) Clear to reset the error state, not cleared by a valid stop bit. Set by hardware when an invalid stop bit is detected.
	SM0	**Serial port Mode bit 0 (SMOD0=0)** Refer to SM1 for serial port mode selection.
6	SM1	**Serial port Mode bit 1** SM0 SM1 Mode Baud Rate 0 0 Shift Register F_{XTAL}/12 (or F_{XTAL} /6 in mode X2) 0 1 8-bit UART Variable 1 0 9-bit UART F_{XTAL}/64 or F_{XTAL}/32 1 1 9-bit UART Variable
5	SM2	**Serial port Mode 2 bit/Multiprocessor Communication Enable bit** Clear to disable multiprocessor communication feature. Set to enable multiprocessor communication feature in mode 2 and 3.
4	REN	**Reception Enable bit** Clear to disable serial reception. Set to enable serial reception.
3	TB8	**Transmitter Bit 8/Ninth bit to transmit in modes 2 and 3** Clear to transmit a logic 0 in the 9th bit. Set to transmit a logic 1 in the 9th bit.
2	RB8	**Receiver Bit 8/Ninth bit received in modes 2 and 3** Cleared by hardware if 9th bit received is a logic 0. Set by hardware if 9th bit received is a logic 1.
1	TI	**Transmit Interrupt flag** Clear to acknowledge interrupt. Set by hardware at the end of the 8th bit time in mode 0 or at the beginning of the stop bit in the other modes.
0	RI	**Receive Interrupt flag** Clear to acknowledge interrupt. Set by hardware at the end of the 8th bit time in mode 0, see Figure 33. and Figure 34. in the other modes.

Reset Value = 0000 0000b
Bit addressable

Table 26. SADEN Register

SADEN (S:B9h)
Slave Address Mask Register

7	6	5	4	3	2	1	0
–	–	–	–	–	–	–	–

Bit Number	Bit Mnemonic	Description
7-0		**Mask Data for Slave Individual Address**

Reset Value = 0000 0000b
Not bit addressable

Table 27. SADDR Register

SADDR (S:A9h)
Slave Address Register

7	6	5	4	3	2	1	0
–	–	–	–	–	–	–	–

Bit Number	Bit Mnemonic	Description
7-0		**Slave Individual Address**

Reset Value = 0000 0000b
Not bit addressable

Table 28. SBUF Register

SBUF (S:99h)
Serial Data Buffer

7	6	5	4	3	2	1	0
–	–	–	–	–	–	–	–

Bit Number	Bit Mnemonic	Description
7-0		**Data sent/received by Serial I/O Port**

Reset Value = 0000 0000b
Not bit addressable

Table 39. TL2 Register

TL2 (S:CCh)
Timer 2 Low Byte Register

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-

Bit Number	Bit Mnemonic	Description
7-0		Low Byte of Timer 2.

Reset Value = 0000 0000b
Not bit addressable

Table 40. RCAP2H Register

RCAP2H (S:CBh)
Timer 2 Reload/Capture High Byte Register

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-

Bit Number	Bit Mnemonic	Description
7-0		High Byte of Timer 2 Reload/Capture.

Reset Value = 0000 0000b
Not bit addressable

Table 41. RCAP2L Register

RCAP2L (S:CA$_H$)
TIMER 2 RELOAD/CAPTURE Low Byte Register

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-

Bit Number	Bit Mnemonic	Description
7-0		Low Byte of Timer 2 Reload/Capture.

Reset Value = 0000 0000b
Not bit addressable

Bit Shortening

If, on the other hand, the transmitter oscillator is faster than the receiver one, the next falling edge used for resynchronization may be too early. So Phase Segment 2 in bit N is shortened in order to adjust the sample point for bit N+1 and the end of the bit time

Synchronization Jump Width

The limit to the amount of lengthening or shortening of the Phase Segments is set by the Resynchronization Jump Width.

This segment may not be longer than Phase Segment 2.

Programming the Sample Point

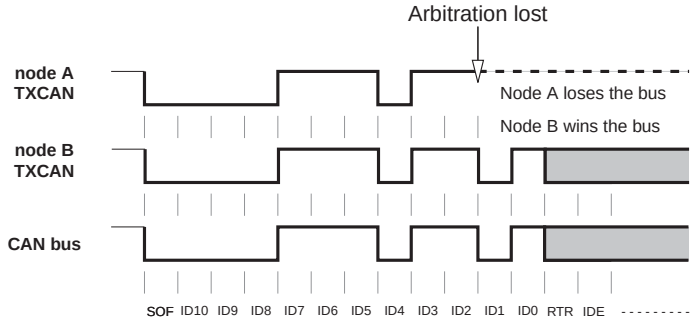
Programming of the sample point allows "tuning" of the characteristics to suit the bus.

Early sampling allows more Time Quanta in the Phase Segment 2 so the Synchronization Jump Width can be programmed to its maximum. This maximum capacity to shorten or lengthen the bit time decreases the sensitivity to node oscillator tolerances, so that lower cost oscillators such as ceramic resonators may be used.

Late sampling allows more Time Quanta in the Propagation Time Segment which allows a poorer bus topology and maximum bus length.

Arbitration

Figure 46. Bus Arbitration



The CAN protocol handles bus accesses according to the concept called “Carrier Sense Multiple Access with Arbitration on Message Priority”.

During transmission, arbitration on the CAN bus can be lost to a competing device with a higher priority CAN Identifier. This arbitration concept avoids collisions of messages whose transmission was started by more than one node simultaneously and makes sure the most important message is sent first without time loss.

The bus access conflict is resolved during the arbitration field mostly over the identifier value. If a data frame and a remote frame with the same identifier are initiated at the same time, the data frame prevails over the remote frame (c.f. RTR bit).

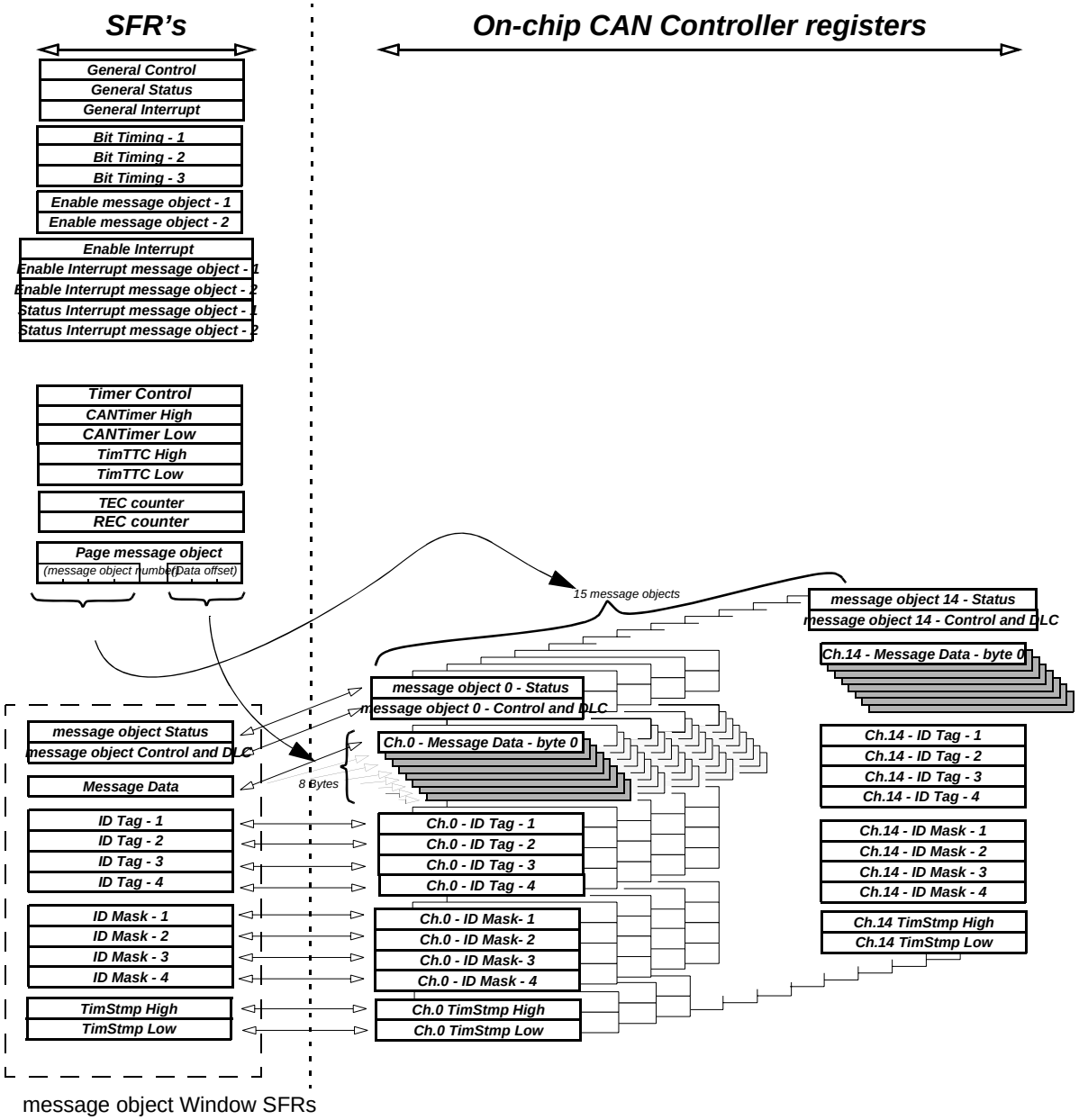
Errors

The CAN protocol signals any errors immediately as they occur. Three error detection mechanisms are implemented at the message level and two at the bit level:

Error at Message Level

- Cyclic Redundancy Check (CRC)
  The CRC safeguards the information in the frame by adding redundant check bits at the transmission end. At the receiver these bits are re-computed and tested against the received bits. If they do not agree there has been a CRC error.
- Frame Check
  This mechanism verifies the structure of the transmitted frame by checking the bit

Figure 48. CAN Controller Memory Organization



- Enable General CAN IT in the interrupt system register,
- Enable interrupt by message object, EICHi,
- Enable interrupt on error, ENERCH.

To enable an interrupt on general error:

- Enable General CAN IT in the interrupt system register,
- Enable interrupt on error, ENERG.

To enable an interrupt on Buffer-full condition:

- Enable General CAN IT in the interrupt system register,
- Enable interrupt on Buffer full, ENBUF.

To enable an interrupt when Timer overruns:

- Enable Overrun IT in the interrupt system register.

When an interrupt occurs, the corresponding message object bit is set in the SIT register.

To acknowledge an interrupt, the corresponding CANSTCH bits (RXOK, TXOK,...) or CANGIT bits (OVRTIM, OVRBUF,...), must be cleared by the software application.

When the CAN node is in transmission and detects a Form Error in its frame, a bit Error will also be raised. Consequently, two consecutive interrupts can occur, both due to the same error.

When a message object error occurs and is set in CANSTCH register, no general error are set in CANGIE register.

Table 48. CANGCON Register

CANGCON (S:ABh)
CAN General Control Register

7	6	5	4	3	2	1	0
ABRQ	**OVRQ**	**TTC**	**SYNCTTC**	**AUTOBAUD**	**TEST**	**ENA**	**GRES**

Bit Number	Bit Mnemonic	Description
7	ABRQ	**Abort Request** Not an auto-resetable bit. A reset of the ENCH bit (message object control and DLC register) is done for each message object. The pending transmission communications are immediately aborted but the on-going communication will be terminated normally, setting the appropriate status flags, TXOK or RXOK.
6	OVRQ	**Overload frame request (initiator)** Auto-resetable bit. Set to send an overload frame after the next received message. Cleared by the hardware at the beginning of transmission of the overload frame.
5	TTC	**Network in Timer Trigger Communication** set to select node in TTC. clear to disable TTC features.
4	SYNCTTC	**Synchronization of TTC** When this bit is set the TTC timer is caught on the last bit of the End Of Frame. When this bit is clear the TTC timer is caught on the Start Of Frame. This bit is only used in the TTC mode.
3	AUTOBAUD	**AUTOBAUD** Set to activate listening mode. Clear to disable listening mode
2	TEST	Test mode. The test mode is intended for factory testing and not for customer use.
1	ENA/$\overline{\text{STB}}$	**Enable/Standby CAN Controller** When this bit is set, it enables the CAN controller and its input clock. When this bit is clear, the on-going communication is terminated normally and the CAN controller state of the machine is frozen (the ENCH bit of each message object does not change). In the standby mode, the transmitter constantly provides a recessive level; the receiver is not activated and the input clock is stopped in the CAN controller. During the disable mode, the registers and the mailbox remain accessible. Note that two clock periods are needed to start the CAN controller state of the machine.
0	GRES	**General Reset (software reset)** Auto-resetable bit. This reset command is ‘ORed’ with the hardware reset in order to reset the controller. After a reset, the controller is disabled.

Reset Value = 0000 0x00b

Table 60. CANBT1 Register

CANBT1 (S:B4h)
CAN Bit Timing Registers 1

7	6	5	4	3	2	1	0
-	BRP 5	BRP 4	BRP 3	BRP 2	BRP 1	BRP 0	-

Bit Number	Bit Mnemonic	Description
7	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
6-1	BRP5:0	**Baud rate prescaler** The period of the CAN controller system clock Tscl is programmable and determines the individual bit timing. $Tscl = \frac{BRP[5..0] + 1}{Fcan}$
0	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.

Note: The CAN controller bit timing registers must be accessed only if the CAN controller is disabled with the ENA bit of the CANGCON register set to 0.
See Figure 52.

No default value after reset.

Table 61. CANBT2 Register

CANBT2 (S:B5h)
CAN Bit Timing Registers 2

7	6	5	4	3	2	1	0
-	SJW 1	SJW 0	-	PRS 2	PRS 1	PRS 0	-

Bit Number	Bit Mnemonic	Description
7	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
6-5	SJW1:0	**Re-synchronization Jump Width** To compensate for phase shifts between clock oscillators of different bus controllers, the controller must re-synchronize on any relevant signal edge of the current transmission. The synchronization jump width defines the maximum number of clock cycles. A bit period may be shortened or lengthened by a re-synchronization. Tsjw = Tscl x (SJW [1..0] +1)
4	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
3-1	PRS2:0	**Programming Time Segment** This part of the bit time is used to compensate for the physical delay times within the network. It is twice the sum of the signal propagation time on the bus line, the input comparator delay and the output driver delay. Tprs = Tscl x (PRS[2..0] + 1)
0	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.

Note: The CAN controller bit timing registers must be accessed only if the CAN controller is disabled with the ENA bit of the CANGCON register set to 0.
See Figure 52.

No default value after reset.

Table 62. CANBT3 Register

CANBT3 (S:B6h)
CAN Bit Timing Registers 3

7	6	5	4	3	2	1	0
-	PHS2 2	PHS2 1	PHS2 0	PHS1 2	PHS1 1	PHS1 0	SMP

Bit Number	Bit Mnemonic	Description
7	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
6-4	PHS2 2:0	**Phase Segment 2** This phase is used to compensate for phase edge errors. This segment can be shortened by the re-synchronization jump width. Tphs2 = Tscl x (PHS2[2..0] + 1) Phase segment 2 is the maximum of Phase segment 1 and the Information Processing Time (= 2TQ).
3-1	PHS1 2:0	**Phase Segment 1** This phase is used to compensate for phase edge errors. This segment can be lengthened by the re-synchronization jump width. Tphs1 = Tscl x (PHS1[2..0] + 1)
0	SMP	**Sample Type** 0 - once, at the sample point. 1 - three times, the threefold sampling of the bus is the sample point and twice over a distance of a 1/2 period of the Tscl. The result corresponds to the majority decision of the three values.

Note: The CAN controller bit timing registers must be accessed only if the CAN controller is disabled with the ENA bit of the CANGCON register set to 0.
See Figure 52.

No default value after reset.

Table 77. CANIDM4 Register for V2.0 part A

CANIDM4 for V2.0 part A (S:C7h)
CAN Identifier Mask Registers 4

7	6	5	4	3	2	1	0
-	-	-	-	-	RTRMSK	-	IDEMSK

Bit Number	Bit Mnemonic	Description
7-3	-	**Reserved** The values read from these bits are indeterminate. Do not set these bits.
2	RTRMSK	**Remote Transmission Request Mask Value** 0 - comparison true forced. 1 - bit comparison enabled.
1	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
0	IDEMSK	**IDentifier Extension Mask Value** 0 - comparison true forced. 1 - bit comparison enabled.

Note: The ID Mask is only used for reception.

No default value after reset.

Table 78. CANIDM1 Register for V2.0 part B

CANIDM1 for V2.0 part B (S:C4h)
CAN Identifier Mask Registers 1

7	6	5	4	3	2	1	0
IDMSK 28	IDMSK 27	IDMSK 26	IDMSK 25	IDMSK 24	IDMSK 23	IDMSK 22	IDMSK 21

Bit Number	Bit Mnemonic	Description
7-0	IDMSK28:21	**IDentifier Mask Value** 0 - comparison true forced. 1 - bit comparison enabled. See Figure 54.

Note: The ID Mask is only used for reception.

No default value after reset.

Bit Number	Bit Mnemonic	Description
4	MODF	**Mode Fault** - Set by hardware to indicate that the $\overline{SS}$ pin is in inappropriate logic level (in both master and slave modes). - Cleared by hardware when reading SPSCR When MODF error occurred: - In slave mode: SPI interface ignores all transmitted data while $\overline{SS}$ remains high. A new transmission is perform as soon as SS returns low. - In master mode: SPI interface is disabled (SPEN=0, see description for SPEN bit in SPCON register).
3	SPTE	**Serial Peripheral Transmit register Empty** - Set by hardware when transmit register is empty (if needed, SPDAT can be loaded with another data). - Cleared by hardware when transmit register is full (no more data should be loaded in SPDAT).
2	UARTM	**Serial Peripheral UART mode** Set and cleared by software: - Clear: Normal mode, data are transmitted MSB first (default) - Set: UART mode, data are transmitted LSB first.
1	SPTEIE	**Interrupt Enable for SPTE** Set and cleared by software: - Set to enable SPTE interrupt generation (when SPTE goes high, an interrupt is generated). - Clear to disable SPTE interrupt generation Caution: When SPTEIE is set no interrupt generation occurred when SPIF flag goes high. To enable SPIF interrupt again, SPTEIE should be cleared.
0	MODFIE	**Interrupt Enable for MODF** Set and cleared by software: - Set to enable MODF interrupt generation - Clear to disable MODF interrupt generation

Reset Value = 00X0 XXXXb

Not Bit addressable

Serial Peripheral DATa Register (SPDAT)

The Serial Peripheral Data Register (Table 94) is a read/write buffer for the receive data register. A write to SPDAT places data directly into the shift register. No transmit buffer is available in this model.

A Read of the SPDAT returns the value located in the receive buffer and not the content of the shift register.

Table 94. SPDAT Register

SPDAT - Serial Peripheral Data Register (0D6H)

7	6	5	4	3	2	1	0
R7	R6	R5	R4	R3	R2	R1	R0

Reset Value = Indeterminate

R7:R0: Receive data bits

Table 97. CCAPnH Registers

CCAP0H (S:FAh)
CCAP1H (S:FBh)
CCAP2H (S:FCh)
CCAP3H (S:FDh)
CCAP4H (S:FEh)
PCA High Byte Compare/Capture Module n Register (n=0..4)

7	6	5	4	3	2	1	0
CCAPnH 7	CCAPnH 6	CCAPnH 5	CCAPnH 4	CCAPnH 3	CCAPnH 2	CCAPnH 1	CCAPnH 0

Bit Number	Bit Mnemonic	Description
7:0	CCAPnH 7:0	High byte of EWC-PCA comparison or capture values

Reset Value = 0000 0000b

Table 98. CCAPnL Registers

CCAP0L (S:EAh)
CCAP1L (S:EBh)
CCAP2L (S:ECh)
CCAP3L (S:EDh)
CCAP4L (S:EEh)
PCA Low Byte Compare/Capture Module n Register (n=0..4)

7	6	5	4	3	2	1	0
CCAPnL 7	CCAPnL 6	CCAPnL 5	CCAPnL 4	CCAPnL 3	CCAPnL 2	CCAPnL 1	CCAPnL 0

Bit Number	Bit Mnemonic	Description
7:0	CCAPnL 7:0	Low byte of EWC-PCA comparison or capture values

Reset Value = 0000 0000b

Electrical Characteristics

Absolute Maximum Ratings

Ambiant Temperature Under Bias:
I = industrial.....-40°C to 85°C A = automotive.....-40°C to +125°C
Voltage on V_{CC} from V_{SS} .....-0.5V to + 6V
Voltage on Any Pin from V_{SS}..... -0.5V to V_{CC} + 0.2V
Power Dissipation ..... 1 W

Note: Stresses at or above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
The power dissipation is based on the maximum allowable die temperature and the thermal resistance of the package.

ICCOP Test Conditions

Power Consumption Management

Since the introduction of the first C51 device, every manufacturer made operating I_{CC} measurements under Reset, which made sense for the designs where the CPU was running under reset. In our new devices, the CPU is no longer active during reset, so the power consumption is very low but not representative of what will happen in the customer system. Thus, while keeping measurements under Reset, we present a new way to measure the operating I_{CC}.

Using an internal test ROM, the following code is executed.

Label: SJMP Label (80FE)

Ports 1 and 4 are disconnected, RST = Vcc, XTAL2 is not connected and XTAL1 is driven by the clock.

This is much more representative of the real operating Icc.

DC Parameters for Standard Voltage

Industrial T_A = -40°C to +85°C; V_{SS} = 0V;
Automotive T_A = -40°C to +125°C; V_{SS} = 0V

V_{CC} =3.0V to 5.5V and F = 0 to 40 MHz (both internal and external code execution)

V_{CC} =4.5V to 5.5V and F = 0 to 60 MHz (internal code execution only)

Table 116. DC Parameters in Standard Voltage

Symbol	Parameter	Min	Typ(5)	Max	Unit	Test Conditions
V_{IL}	Input Low Voltage	-0.5		0.2Vcc - 0.1	V	
V_{IH}	Input High Voltage except XTAL1, RST	0.2 V_{CC} + 0.9		V_{CC} + 0.5	V	
V_{IH1}	Input High Voltage, XTAL1, RST	0.7 V_{CC}		V_{CC} + 0.5	V	
V_{OL}	Output Low Voltage, ports 1, 2, 3 and 4(6)			0.3 0.45 1.0	V V V	I_{OL} = 100 µA(4) I_{OL} = 1.6 mA(4) I_{OL} = 3.5 mA(4)
V_{OL1}	Output Low Voltage, port 0, ALE, $\overline{PSEN}$ (6)			0.3 0.45 1.0	V V V	I_{OL} = 200 µA(4) I_{OL} = 3.2 mA(4) I_{OL} = 7.0 mA(4)

Table 116. DC Parameters in Standard Voltage (Continued)

Symbol	Parameter	Min	Typ[5]	Max	Unit	Test Conditions
V_{OH}	Output High Voltage, ports 1, 2, 3, and 4	V_{CC} - 0.3 V_{CC} - 0.7 V_{CC} - 1.5			V V V	I_{OH} = -10 µA I_{OH} = -30 µA I_{OH} = -60 µA V_{CC} = 3V to 5.5V
V_{OH1}	Output High Voltage, port 0, ALE, $\overline{PSEN}$	V_{CC} - 0.3 V_{CC} - 0.7 V_{CC} - 1.5			V V V	I_{OH} = -200 µA I_{OH} = -3.2 mA I_{OH} = -7.0 mA V_{CC} = 5V ± 10%
R_{RST}	RST Pulldown Resistor	20	100	200	kΩ	
I_{IL}	Logical 0 Input Current ports 1, 2, 3 and 4			-50	µA	Vin = 0.45V
I_{LI}	Input Leakage Current			±10	µA	0.45V < Vin < V_{CC}
I_{TL}	Logical 1 to 0 Transition Current, ports 1, 2, 3 and 4			-650	µA	Vin = 2.0V
C_{IO}	Capacitance of I/O Buffer			10	pF	Fc = 1 MHz T_A = 25°C
I_{PD}	Power-down Current Industrial		75	150	µA	3V < V_{CC} < 5.5V[3]
	Power-down Current Automotive		100	350	µA	3V < V_{CC} < 5.5V[3]
I_{CC}	Power Supply Current	I_{CCOP} = 0.4 Frequency (MHz) + 8 I_{CCIDLE} = 0.2 Frequency (MHz) + 8			mA	Vcc = 5.5V[1][2]
$I_{CCWRITE}$	Power Supply Current on flash or EEdata write			0.8 x Frequency (MHz) + 15	mA	V_{CC} = 5.5V

Notes:
1. Operating I_{CC} is measured with all output pins disconnected; XTAL1 driven with T_{CLCH}, T_{CHCL} = 5 ns (see Figure 81.), V_{IL} = V_{SS} + 0.5V,
   V_{IH} = V_{CC} - 0.5V; XTAL2 N.C.; $\overline{EA}$ = RST = Port 0 = V_{CC}. I_{CC} would be slightly higher if a crystal oscillator used (see Figure 78.).
2. Idle I_{CC} is measured with all output pins disconnected; XTAL1 driven with T_{CLCH}, T_{CHCL} = 5 ns, V_{IL} = V_{SS} + 0.5V, V_{IH} = V_{CC} - 0.5V; XTAL2 N.C; Port 0 = V_{CC}; $\overline{EA}$ = RST = V_{SS} (see Figure 79.).
3. Power-down I_{CC} is measured with all output pins disconnected; $\overline{EA}$ = V_{CC}, PORT 0 = V_{CC}; XTAL2 NC.; RST = V_{SS} (see Figure 80.). In addition, the WDT must be inactive and the POF flag must be set.
4. Capacitance loading on Ports 0 and 2 may cause spurious noise pulses to be superimposed on the V_{OL}s of ALE and Ports 1 and 3. The noise is due to external bus capacitance discharging into the Port 0 and Port 2 pins when these pins make 1 to 0 transitions during bus operation. In the worst cases (capacitive loading 100pF), the noise pulse on the ALE line may exceed 0.45V with maxi V_{OL} peak 0.6V. A Schmitt Trigger use is not necessary.
5. Typicals are based on a limited number of samples and are not guaranteed. The values listed are at room temperature.
6. Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows:
   Maximum I_{OL} per port pin: 10 mA
   Maximum I_{OL} per 8-bit port:
   Port 0: 26 mA
   Ports 1, 2, 3 and 4: 15 mA
   Maximum total I_{OL} for all output pins: 71 mA
   If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.